

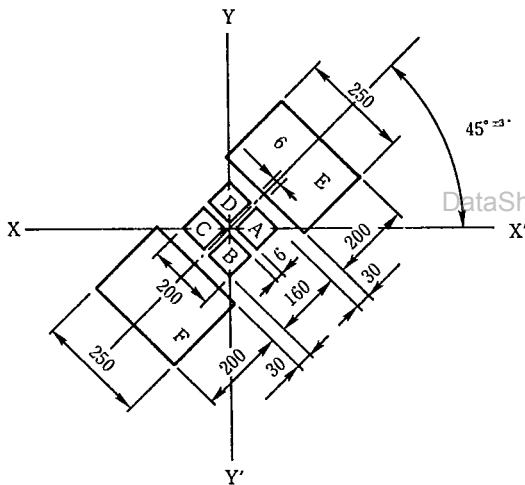
■ Features

1. Built-in high-speed amplifier for video signal
(High cut-off frequency f_c : TYP. 20MHz)
2. Fine pitch
(Chip separation width: $6\mu\text{m}$)
3. Compact 10-pin flat package

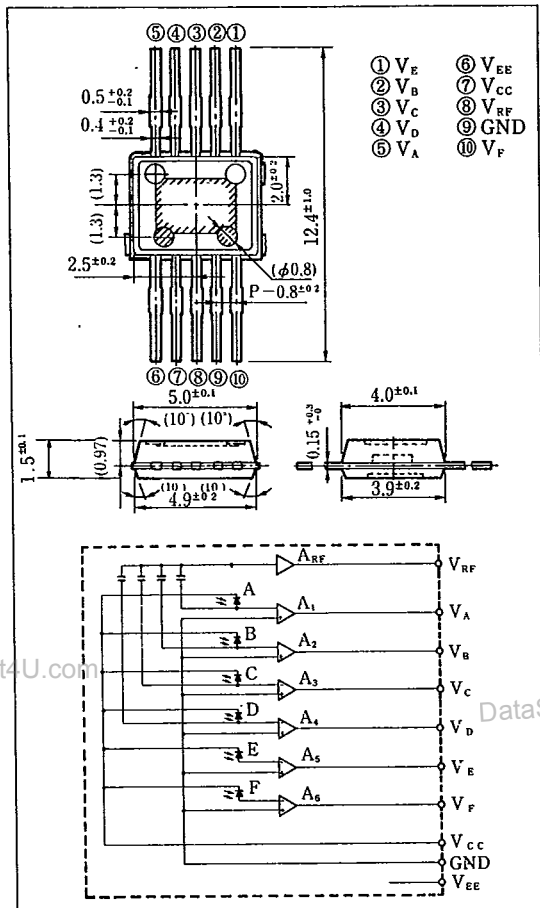
■ Applications

1. Laser disk players
2. CDVs

Enlarged drawing of detector portion (Unit: μm)



■ Outline Dimensions (Unit: mm)



※ OPIC is a trademark of Sharp and stands for Optical IC. It has a light detecting element and signal processing circuitry integrated onto a single chip.

■ Absolute Maximum Ratings

(T_a = 25°C)

Parameter	Symbol	Rating	Unit
Supply voltage 1	V _{CC}	6	V
Supply voltage 2	V _{EE}	-6	V
Power dissipation	P	210	mW
Operating temperature	T _{opr}	-20 ~ +65	°C
Storage temperature	T _{stg}	-40 ~ +85	°C
*1 Soldering temperature	T _{sol}	260	°C

* 1 For 3 seconds at the position of 1mm from the surface of resin edge.

■ Electro-optical Characteristics

 $(V_{CC}=5V, V_{EE}=-5V, T_a=25^\circ C)$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	Applicable terminals
Supply current 1	I_{CC}	No light	—	6	10	mA	
Supply current 2	I_{EE}	No light	-14	-9	—	mA	
RF output off-set voltage	V_{OR}	No light	0	1.0	2.0	V	V_{RF}
Output off-set voltage	V_{OD}	No light	-20	0	+20	mV	V_A, V_B, V_C, V_D
Extremes of off-set voltage	ΔV_{OD}	No light	-20	0	+20	mV	*1
Sensitivity	R_{PRF}	$\lambda = 780nm$	20	30	40	mV/ μW	V_{RF}
	R_{PD}		16	24.5	33	mV/ μW	$V_A, V_B, V_C, V_D, V_E, V_F$
Response frequency	$^{*2}f_{CRFL}$	$R_L = 10k\Omega$ $C_L = 10pF$ -3dB	—	25	35	kHz	V_{RF}
	$^{*2}f_{CRFH}$		15	20	—	MHz	V_{RF}
	$^{*3}f_{CF}$		15	25	—	kHz	V_A, V_B, V_C, V_D
	$^{*3}f_{CT}$		150	250	—	kHz	V_E, V_F
RF output noise level	V_n	$f=8MHz$ $BW=30kHz$	—	-75	-69	dBm	V_{RF}

* 1 $(V_A + V_C) - (V_B + V_D), V_E - V_F$

* 2 Response frequency shall measure the frequency at the output -3dB from the output value modulated at the frequency 1MHz.

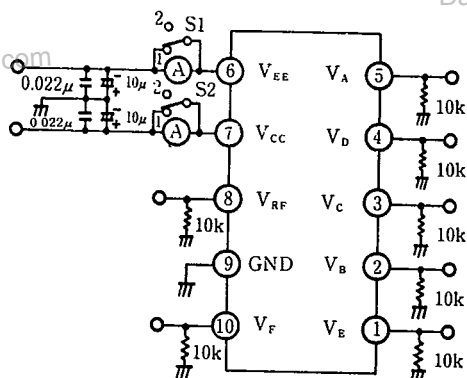
* 3 Response frequency shall measure the frequency at the output -3dB from the output value modulated at the frequency 1kHz.

■ Recommended Operating Conditions

Parameter	Symbol	MIN.	MAX.	Unit
Supply voltage 1	V_{CC}	4.5	5.5	V
Supply voltage 2	V_{EE}	-4.5	-5.5	V

Test circuit

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(Switching conditions)

S1 switch shall connect to terminal 2 when measuring I_{EE} , and S1 switch shall connect to terminal 1 when measuring the other electrical characteristics.

S2 switch shall connect to terminal 2 when measuring I_{CC} , and S2 switch shall connect to terminal 2 when measuring the other electrical characteristics.

(Incident light conditions)

(i) Laser diode shall be used as a light source.(780nm \pm 5nm)

(ii) Incident light intensity shall be $\begin{cases} 30\mu W & \text{at not modulating} \\ 30+10 \sin(t)\mu W & \text{at modulating.} \end{cases}$

(iii) Diameter of spot during irradiance shall be 40 μm , and the center of photodiode shall be positioned at the center of spot.

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Fig. 1 Power Dissipation vs. Ambient Temperature

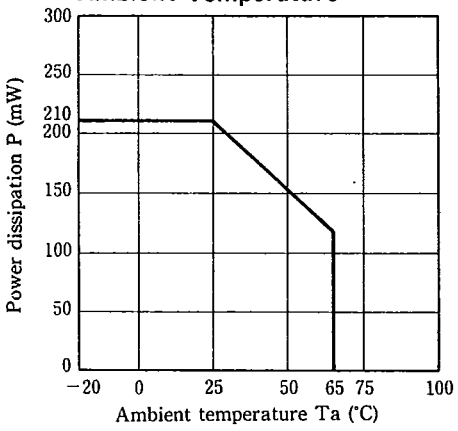


Fig. 2 Sensitivity vs. Input Signal Frequency

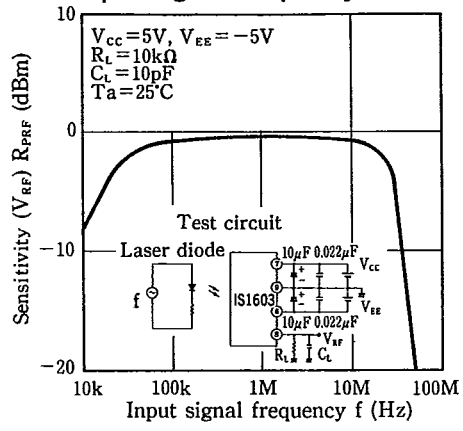


Fig. 3 Response Frequency vs. Supply Voltage

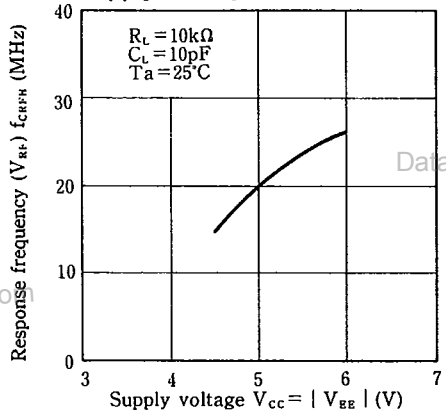


Fig. 4 Response Frequency vs. Ambient Temperature

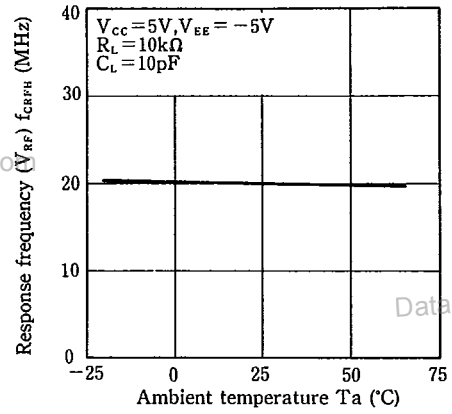


Fig. 5 RF Output Noise Level vs. Supply Voltage

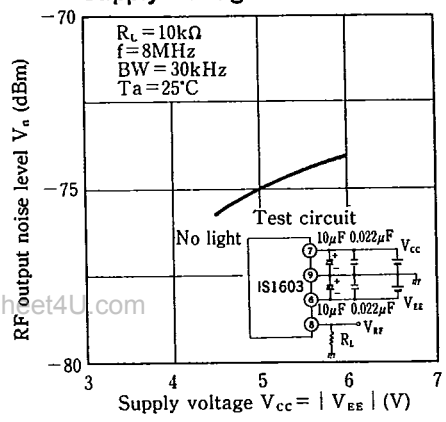


Fig. 6 RF Output Noise Level vs. Ambient Temperature

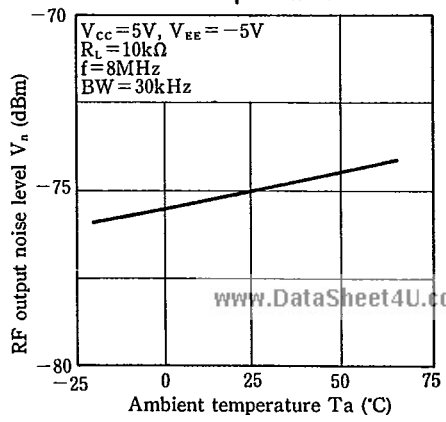


Fig. 7 RF Output Off-set Voltage vs. Supply Voltage

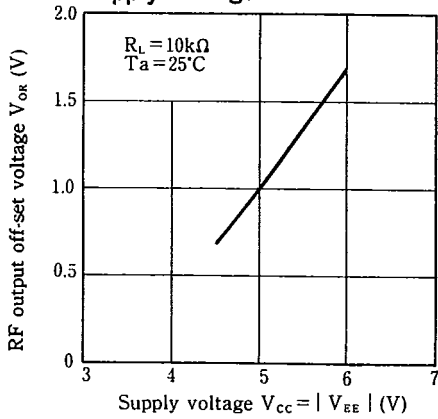


Fig. 8 RF Output Off-set Voltage vs. Ambient Temperature

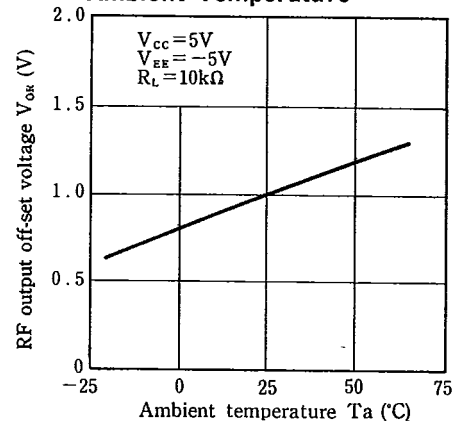


Fig.9 Output Off-set Voltage vs. Supply Voltage

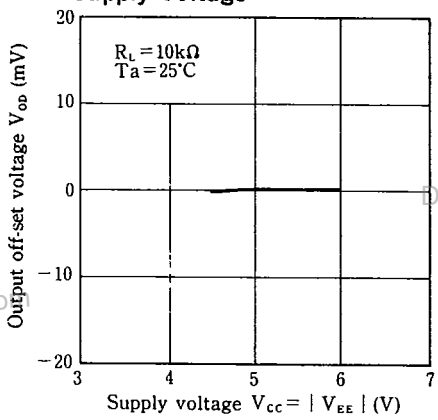


Fig.10 Output Off-set Voltage vs. Ambient Temperature

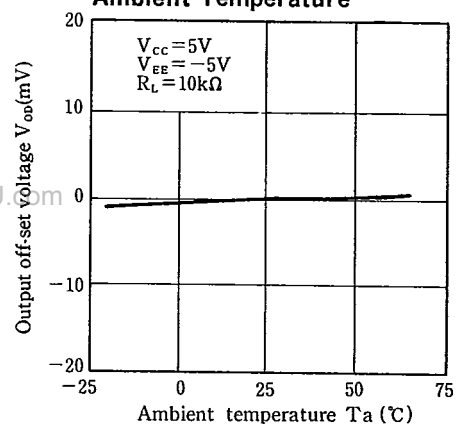


Fig. 11 Supply Current vs. Supply Voltage

